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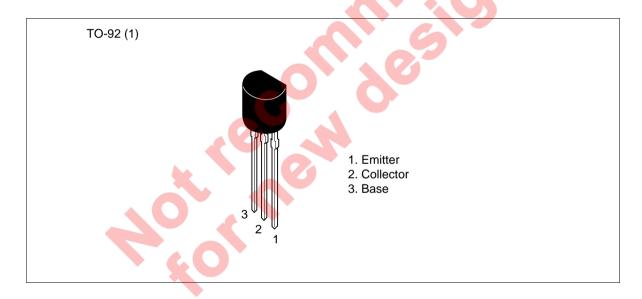
Silicon PNP Epitaxial



#### **Application**

- Low frequency low noise amplifier
- Complementary pair with 2SC2545, 2SC2546 and 2SC2547

#### Outline



### **Absolute Maximum Ratings** (Ta = 25°C)

Item	Symbol	2SA1083	2SA1084	2SA1085	Unit
Collector to base voltage	$V_{\text{CBO}}$	-60	-90	-120	V
Collector to emitter voltage	V <sub>CEO</sub>	-60	-90	-120	V
Emitter to base voltage	$V_{EBO}$	<b>-</b> 5	<b>-</b> 5	<b>–</b> 5	V
Collector current	I <sub>c</sub>	-100	-100	-100	mA
Emitter current	I <sub>E</sub>	100	100	100	mA
Collector power dissipation	P <sub>c</sub>	400	400	400	mW
Junction temperature	Tj	150	150	150	°C
Storage temperature	Tstg	-55 to +150	-55 to +150	-55 to +150	°C

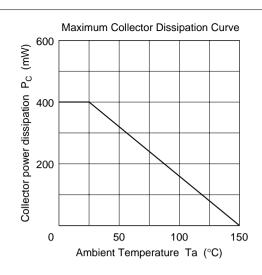
## Electrical Characteristics ( $Ta = 25^{\circ}C$ )

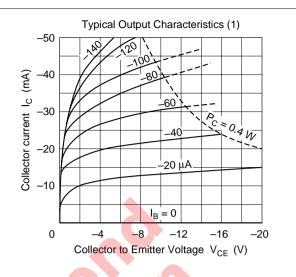
		2SA1	1083		2SA1084		2SA1085					
Item	Symbol	Min	Тур	Max	Min	Тур	Max	Min	Тур	Max	Unit	Test conditions
Collector to base breakdown voltage	$V_{(BR)CBO}$	-60	_	_	-90	_	_	-120	_	_	V	$I_{C} = -10 \mu A, I_{E} = 0$
Collector to emitter breakdown voltage	$V_{(BR)CEO}$	-60	_	_	-90	_	_	-120	_	-	V	$I_C = -1 \text{ mA},$ $R_{BE} = \infty$
Emitter to base breakdown voltage	V <sub>(BR)EBO</sub>	-5	_	_	<b>-</b> 5	_	_	-5	_	_	V	$I_E = -10 \mu A, I_C = 0$
Collector cutoff current	I <sub>CBO</sub>	_	_	-0.1	_	_	-0.1	_	_	-0.1	μΑ	$V_{CB} = -50 \text{ V}, I_{E} = 0$
Emitter cutoff current	I <sub>EBO</sub>	_	_	-0.1	_	_	-0.1	_	_	-0.1	μА	$V_{EB} = -2 \text{ V}, I_{C} = 0$
DC current transfer ratio	h <sub>FE</sub> *1	250	_	800	250	_	800	250	7	800		$V_{CE} = -12 \text{ V},$ $I_{C} = -2 \text{ mA}$
Collector to emitter saturation voltage	V <sub>CE(sat)</sub>	_	_	-0.2	_	_	-0.2	7		-0.2	V	$I_C = -10 \text{ mA},$ $I_B = -1 \text{ mA}$
Base to emitter voltage	$V_{BE}$	_	-0.6	_	_	-0.6	4		-0.6	0	V	$V_{CE} = -12 \text{ V},$ $I_{C} = -2 \text{ mA}$
Gain bandwidth product	f <sub>T</sub>	_	90	_	-	90		_	90		MHz	$V_{CE} = -12 \text{ V},$ $I_{C} = -2 \text{ mA}$
Collector output capacitance	Cob	_	3.5	_	<b>5</b>	3.5	7	U	3.5	_	pF	$V_{CB} = -10 \text{ V}, I_{E} = 0,$ f = 1 MHz
Noise voltage reffered to input	e <sub>n</sub>	-	0.5	<b>5</b>	_	0.5		_	0.5	_	nV/ √Hz	$V_{CE} = -6V,$ $I_{C} = -10 \text{ mA},$ $f = 1 \text{ kHz},$ $R_{g} = 0, \Delta f = 1 \text{Hz}$

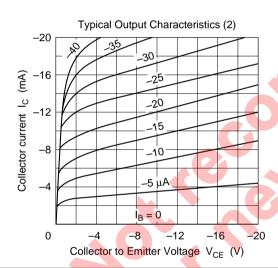
Note: 1. The 2SA1083, 2SA1084 and 2SA1085 are grouped by  $h_{\text{FE}}$  as follows.

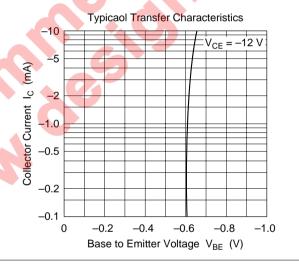
D	E
250 to 500	400 to 800

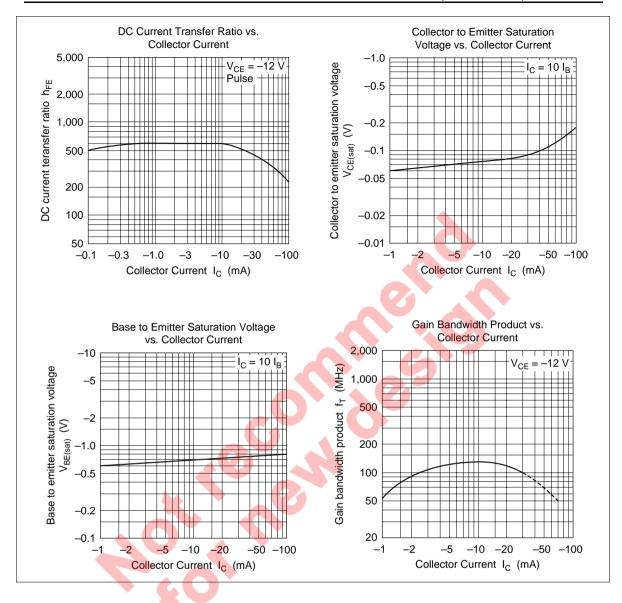


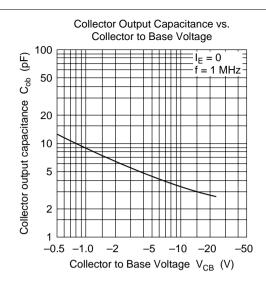


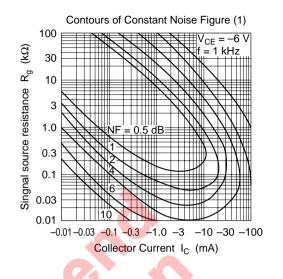


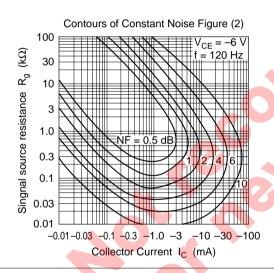


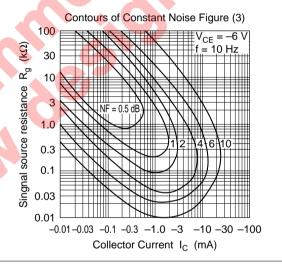












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